For Driving Low-Threshold-Voltage MOS Inputs

SN5426 . . . J PACKAGE SN54LS26 . . . J OR W PACKAGE SN7426 . . . N PACKAGE SN74LS26 . . . D OR N PACKAGE (TOP VIEW) 14 🗖 1 J 14口 Vcc 13 4B 12 4A 1B 🛮 2 1Y 🗆 11 4Y 2A 🗆 4 **2B** 🗖 5 10 3B 9 3A 2Y 🛚 GND 🗀 8 3Y

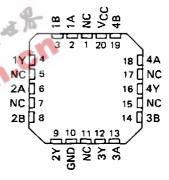
description

GND 7 SN54LS26.

These 2-input open-collector NAND gates feature high-output voltage ratings for interfacing with low-threshold-voltage MOS logic circuits or other 12-volt systems. Although the output is rated to withstand 15 volts, the V_{CC} terminal is connected to the standard 5-volt source.

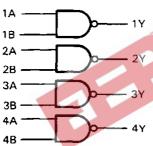
SN54LS26 . . . FK PACKAGE (TOP VIEW)

The SN5426 and SN54LS26 are characterized for operation over the full military temperature range of -55°C to 125°C. The SN7426 and SN74LS26 are characterized for operation from 0°C to 70°C.



logic diagram

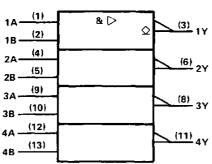
NC - No internal connection



positive logic

$$Y = \overline{AB}$$

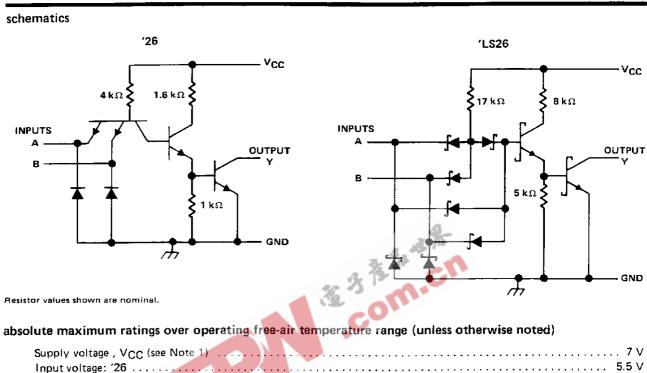
logic symbol[†]



 $^{^\}dagger$ This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

SN5426, SN54LS26, SNSN7426, SN74LS26 QUADRUPLE 2-INPUT HIGH-VOLTAGE INTERFACE POSITIVE-NAND GATES



Supply voltage , VCC (see Note 1)	
Input voltage: '26	., 5.5 V
'LS26	7 V
Operating free-air temperature: SN54'	– 55°C to 125°C
SN74'	,, 0°C to 70°C
Storage temperature range	– 65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

	\$	SN54LS26			SN74LS26		
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
V _{CC} Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{JH} High-level input voltage	2			2			V
VIL Low-level input voltage			0.7			0.8	V
VOH High-level output voltage			15			15	V
IOL Law-level output current			4			8	mA
TA Operating free-air temperature	– 55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS†		SN54LS26		SN74LS26			LIBUT			
PANAMETER		LEST COMPLITIONS.			MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
Vik	V _{CC} = MIN,	I ₁ = 18 mA				-0	- 1.5			– 1.5	V
юн	V _{CC} = MIN,	VIL = MAX,	V _{OH} = 12 V		.31	10	50			50	μΑ
	V _{CC} = MIN,	VIL = MAX,	V _{OH} = 15 V		4,00		1			1	mΑ
V	V _{CC} = MIN,	V _{1H} = 2 V,	I _{OL} = 4 mA	. 26	3.	0.25	0.4		0.25	0.4	
V ^{OL}	V _{CC} = MIN,	V _{1H} = 2 V,	IOL = 8 mA	40 3	-0				0.35	0.5	٧
l ₁	V _{CC} = MAX,	V _I = 7 V	4	132	Cr.		0.1			0.1	mΑ
IН	V _{CC} = MAX,	V _{IH} = 2.7 V		P. U			20			20	μΑ
ΗL	V _{CC} = MAX,	V _{IL} = 0.4 V	4				- 0.4			- 0.4	mΑ
Іссн	V _{CC} = MAX,	V _I = 0	11			0.8	1.6		8.0	1.6	mA
ICCL	V _{CC} = MAX,	V ₁ = 4.5 V				2.4	4.4		2.4	4.4	

[†] For conditions shown as M1N or MAX, use the appropriate value specified under recommended operating conditions. ‡ All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see note 2)

PARAMETER	FROM (INPUT)	TO TEST CONDITIONS		MIN TYP	MAX	UNIT
tPLH .	A or B	~	$R_1 = 2 k\Omega$, $C_1 = 15 pF$	17	32	ns
t P HL	7016	'	H[+2K22, C[-15]F	15	28	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

SN5426, SN7426 QUADRUPLE 2-INPUT HIGH-VOLTAGE INTERFACE POSITIVE-NAND GATES

recommended operating conditions

			SN5426			SN7426		
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	$\overline{}$
v_{IH}	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.8			0.8	v
Voн	High-level output voltage			15			15	V
loL	Low-level output current			16			16	mΑ
TA	Operating free-air temperature	– 55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED.	TEST CONDITIONS†	SN5426	\$N7426		
PARAMETER	TEST CONDITIONS.	MIN TYP# MAX	MIN TYP‡ MAX	UNIT	
VIK	VCC = MIN, I _I ≈ -12 mA	-1.5	-1.5	V	
	V _{CC} = MIN, V _{IL} = 0.8 V, V _{OH} = 12 V	. %4	50		
I	$V_{CC} = MIN$, $V_{IL} = 0.7 \text{ V}$, $V_{OH} = 12 \text{ V}$	50		μΑ	
ЮН	$V_{CC} = MIN$, $V_{IL} = 0.8 \text{ V}$, $V_{OH} = 15 \text{ V}$	-0.4	1		
	$V_{CC} = MIN$, $V_{IL} = 0.7 \text{ V}$, $V_{OH} = 15 \text{ V}$	1		mΑ	
VoL	V _{CC} = MIN, V _{IH} = 2 V, I _{OL} = 16 mA	0.4	0.4	V	
<u> </u>	V _{CC} = MAX, V _I = 5.6 V	1	1	mA	
ін	$V_{CC} = MAX$, $V_1 = 2.4 \text{ V}$	40	40	μΑ	
<u>-</u> -լլլ	$V_{CC} = MAX$, $V_{I} = 0.4 \text{ V}$	-1.6	-1.6	mΑ	
іссн	$V_{CC} = MAX, V_{\parallel} = 0$	4 8	4 8	mA	
CCF	$V_{CC} = MAX$, $V_I = 4.5 V$	12 22	12 22	mA	

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, VCC = 5 V, TA = 25°C (see note 2)

 PARAMETER	FROM (INPUT)	TQ (OUTPUT)	TEST CONDITIONS		MIN TYP	MAX	UNIT
[†] PLH	A or B	~	$R_1 = 1 k\Omega$	C. = 15.05	16	24	ns
^t PHL	7010	•	ML = 1 K32,	C _L = 15 pF	11	17	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

 $^{^{\}ddagger}$ All typical values are at VCC = 5 V, TA = 25 °C.

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